

The 2027 IEEE International Workshop on Integrated Power

Packaging (IWIPP 2027)

Sponsorship Prospectus

The 2027 IEEE International Workshop on Integrated Power Packaging (IWIPP 2027) will be held on Feb. 28 – Mar. 4, 2027, at Kitakyushu International Conference Center in Kitakyushu, Fukuoka, Japan.

The first IWIPP was held in 1998 at the Congress Plaza Hotel in Chicago, IL, USA. After the 2000 edition in Waltham, MA, IWIPP went on a 15-year hiatus and returned to its Chicago roots in 2015. After the success of IWIPP 2017, 2019 and 2022 in Europe, IWIPP returned to the United States in 2025 and was hosted in Tuscaloosa, Alabama. The next IWIPP will be held in Japan making its first edition in Asia-Pacific.

The purpose of this workshop is to bring together researchers in the field of power electronic components, electrical insulating materials, and packaging technologies to promote the development and commercialization of high-density and high-efficiency power converters. Papers are sought that address important challenges in power electronic components and systems and present solutions to increase reliability and manufacturability while targeting increased performance and reduced system cost.

The workshop aims to provide the opportunity to engage in a meaningful discussion about the latest technologies and techniques in both industry and academia, and from early-stage research to volume manufacturing, ensuring that a learning environment is fostered for all.

Sincerely,
Ichiro Omura
General Chair, IWIPP 2027

Workshop Outline

Symposium Name: The 2027 IEEE International Workshop on Integrated Power Packaging (IWIPP 2027)

Dates: Feb. 28 (Sun.), 2027 – Mar. 4 (Thu.), 2027

Schedule: Feb. 28 (Sun.) Tutorial, Mar. 1 (Mon.) -Mar. 3 (Wed.) Workshop, Mar. 4 (Thu.) Lab tour, 2 Keynote talks and 4 invited talks

Venue: Kitakyushu International Conference Center

Expected Number of participants: 200-300 attendees

(Academia: 40%, Industry: 60%, International attendees: approximately 100)

Expected Number of Presentations: 60

General Chair: Ichiro Omura (Kyushu Institute of Technology)

General Co-Chair: Shiori Idaka (Mitsubishi Electric Europe)

Technical Program Chairs: Naoto Fujishima (Fuji Electric), Hiroshi Kono (Kyushu Institute of Technology)

Sponsors: IEEE, IEEE Power Electronics Society (PELS), IEEE Electronics Packaging Society (EPS), IEEE Dielectrics & Electrical Insulation Society (DEIS), Power Sources Manufacturers Association (PSMA)

Technical Co-Sponsor: ECPE European Center for Power Electronics e.V. (ECPE)

Main Categories of Interest:

1. Device and Application: Power Semiconductor Devices, Die attach and wire bonding, Packaging Materials, High Temperature & High Voltage Dielectrics, Interconnection technologies, Printed Circuit Boards (PCB), High-Frequency Magnetics, Thermal Interface Materials, Electromagnetic Interference
2. Integration and Design: Design for Manufacturability, Compatibility with Standards Innovative packaging strategies, High-Temperature Capacitors, System Integration and Optimization, Compact Converter Design Techniques, Gate/Base Drivers, Sensors & Protection
3. Reliability and Test: Components to System Reliability, Reliability Assessment & Lifetime Prediction, Partial Discharge, Thermal Management, Power Cycling, Environmental test, Failure analysis

Secretariat: ENHAL Inc. 1-8-9 Uchikanda Chiyoda-ku, Tokyo JAPAN

E-mail: watanabe@enhal.com, fumi-yoshi.kawashiro.r38@mail.toshiba

Sponsorship Packages

Items / Packages	Diamond	Gold	Silver	Exhibitor (Hall)	Exhibitor (Room)
Contribution Fee	¥800,000	¥500,000	¥250,000	¥400,000	¥100,000
Logo on Website	Large	Medium	Small	Medium	Small
Logo in Program Book	Large	Medium	Small	Medium	Small
Logo on Screens in Hall	Large	Medium	Small	—	—
Logo on Signboards/Banners	Large	Medium	—	—	—
Badge Lanyard Brand	✓ (Exclusive)	—	—	—	—
Complimentary Passes (Symposium & Banquet)	2 Tickets	1 Ticket	—	—	—
Exhibitor Presentation	—	—	—	✓ (2-3 mins)	✓ (2-3 mins)
Exhibition Booth	—	—	—	Hall Booth (3x2m or 2x2m)	Room Booth (1.8m Table)

Note

- TAX included.
- Sponsor packages (Diamond, Gold and Silver) do NOT include the opportunity to present at the Industrial Session or an exhibit booth. Be sure to also register as an exhibitor if you need them.

Diamond Sponsor JPY800,000

Premium Visibility: Prominent placement of the corporate logo featured prominently on the official website, session screens in the main hall, printed program books, and venue signboards/banners. Exclusive Badge Lanyard: Exclusive corporate branding on the official badge lanyards distributed to all workshop attendees. Complimentary Registration: Includes 2 full complimentary passes for both the Technical Symposium and the Banquet.

Gold Sponsor JPY500,000

Enhanced Visibility: Medium-sized corporate logo featured on the official

website, session screens in the main hall, printed program books, and venue signboards/banners. Complimentary Registration: Includes 1 full complimentary pass for both the Technical Symposium and the Banquet.

Silver Sponsor JPY250,000

Brand Recognition: Small-sized corporate logo featured on the official website, session screens in the main hall, and printed program books.

Exhibitor (Main Hall) JPY400,000

Premium Exhibition Space: Dedicated exhibition booth located within the main hall (3x2m or 2x2m space).

Exhibitor Presentation: Opportunity to deliver a 2-to-3-minute short presentation during designated technical sessions.

Branding: Medium-sized corporate logo featured on the official website and in printed program books.

Exhibitor (Exhibition Room) JPY100,000

Standard Exhibition Space: Tabletop exhibition space (1.8m table) located within the exhibition room.

Exhibitor Presentation: Opportunity to deliver a 2-to-3-minute short presentation during designated technical sessions.

Branding: Small-sized corporate logo featured on the official website and in printed program books.

Exhibition Outline

Venue: Kitakyushu International Conference Center

Dates:

Setting up: Feb. 28 (Sun.) 16:00-18:00 (to be confirmed)

Opening Hours:

Mar. 1 (Mon.) 9:00-17:00

Mar. 2 (Tue.) 9:00-17:00

Mar. 3 (Wed) 9:00-14:00

Bump-out: Mar. 3, 14:30-

* Schedule is subject to change. Finalized schedule to be shared in due course.

Exhibition Area: Event Hall adjacent to the Main Hall (Same area with Poster presentation) & Extra Conference Room

Exhibition Fee: JPY400,000 (Event Hall) / JPY100,000 (Meeting Room 11)

Booth Number: Maximum 16 booths in the Event Hall and 8 booths in Meeting Room

Up to 2 booths can be booked per company.

The booth can be chosen on the first-come, first-served basis.

Once all booths are fully booked, the application will be closed.

Benefit

PR opportunities:

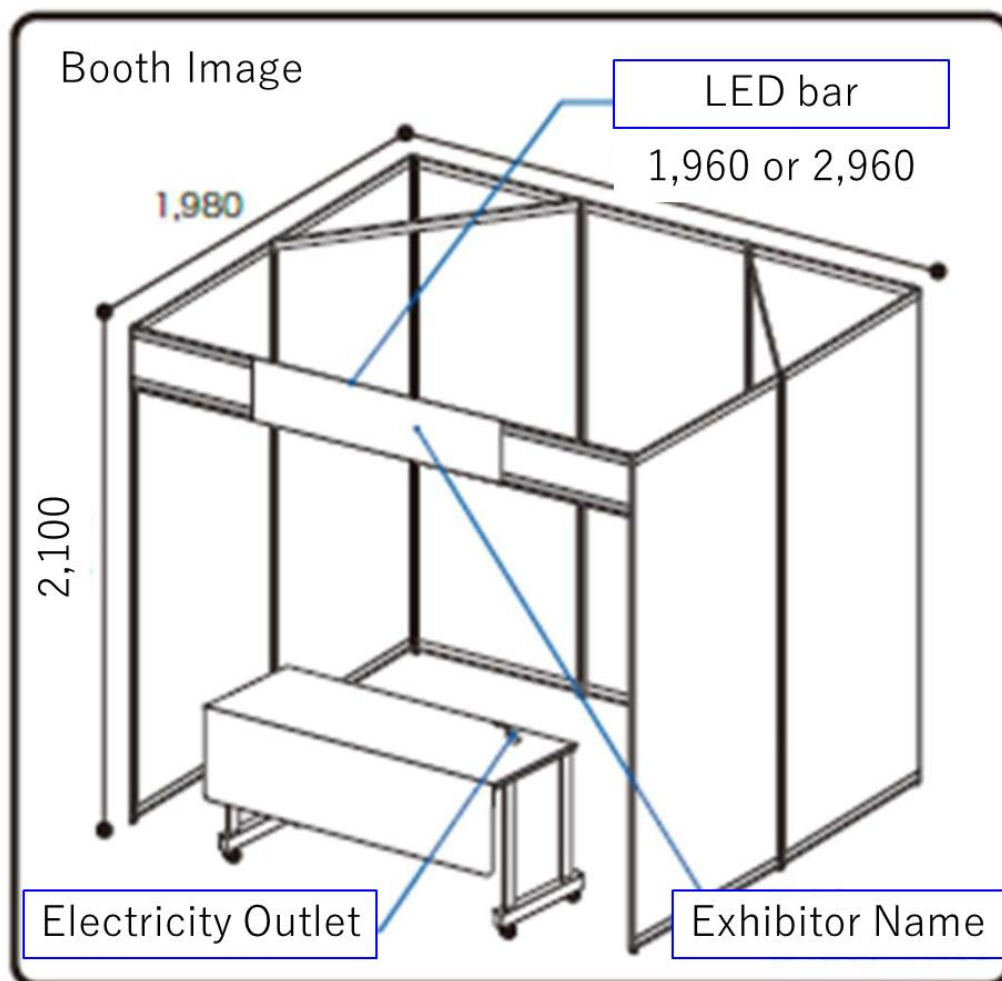
Company logo on the official website and in the symposium program book.

A 2–3-minute company introduction at the Industrial Session which will be held after Tutorial on Feb. 28.

(Light refreshments will be provided for the participants)

Booth Specifications

- ✓ 3.0 m x 2.0 m or 2.0 m x 2.0 m per booth
- ✓ Wall panels on both sides (Approx. 2.7 m height)
- ✓ 1 company name sign (W:0.9 m x H:2m, white base, black letters)
- ✓ Company name plate design to be standardized for all booths
- ✓ One LED light per booth
- ✓ Two electrical outlets (AC 100V/60Hz, A-type),
- ✓ 1 table (W:1.8 m x D:0.45 m x H:0.7 m) with 2 chairs



Note

- Optional items (i.e. catalogue stands, extra chairs, monitor, etc.) will be arranged upon request.

Exhibition Layout (1st Floor)

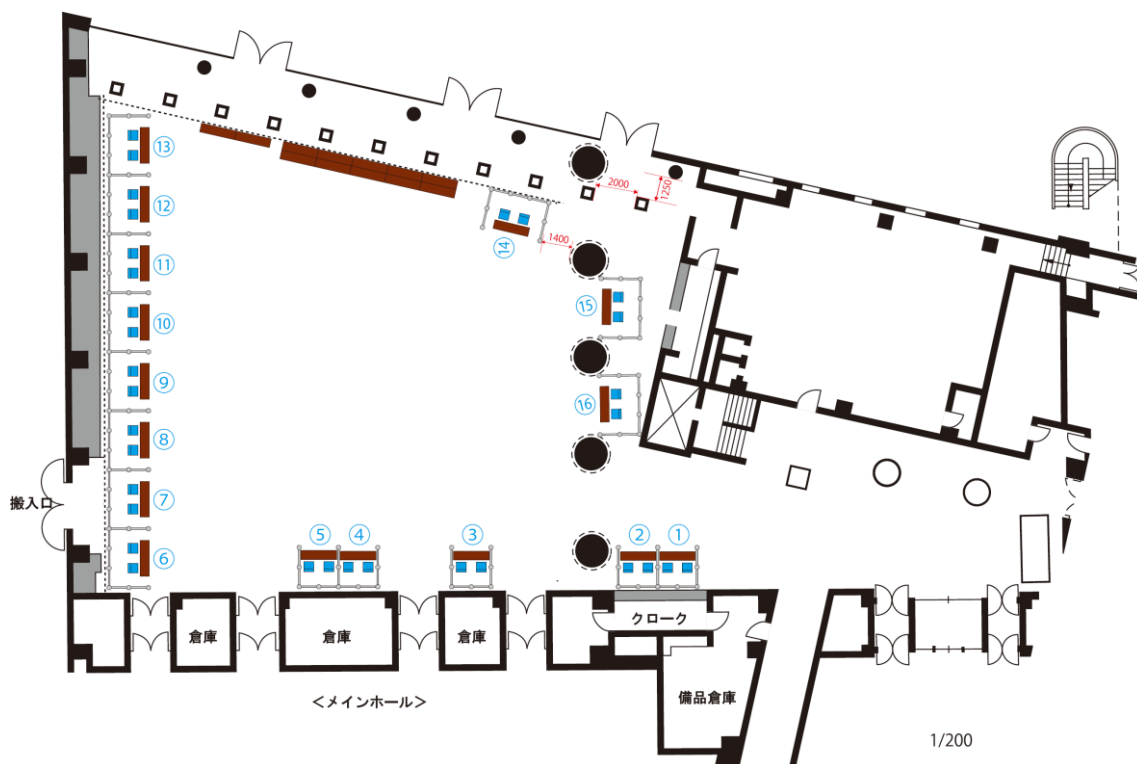
Venue: Kitakyushu International Conference Center

9-30, Asano 3-chome, Kokurakita-ku, Kitakyushu City, Fukuoka Prefecture, 802-0001

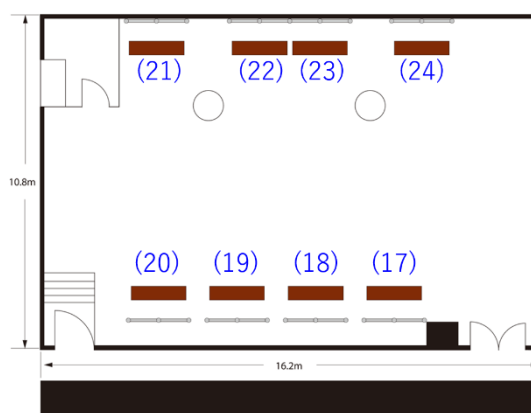
TEL: +81-93-511-4422, FAX: +81-930541-5928

Exhibition Area: Event hall & Meeting Room 11 on the 1st floor.

- ✓ Coffee service during coffee breaks will be provided at the Event Hall.
- ✓ Note that the oral sessions are held at the Main Hall adjacent to the Event Hall.



Event Hall



Meeting Room 11

Important Notice for Exhibitors

Exhibitors are asked to follow the regulations set by the Organizer and Venue.

[Prohibited Actions]

There are height restrictions on decorations and exhibits. Please consult with the Sponsor Office in advance. Direct construction on the floor (duct tape, anchor, etc.) is prohibited generally. Power supply, electricity, cleaning, and garbage disposal fees will be charged separately.

[Electricity, Water Supply and Drainage]

Electricity (Single-phase, two-wire, 100 V 60Hz) will be supplied at the exhibitor's request for a fee. If you wish to use this service, please contact the Sponsor's Secretariat. In principle, the use of water, propane gas and compressed air is prohibited.

[Booth allocation]

Booths can be selected by exhibitors, and they are taken on the first-come, first-served basis. Exhibitors are prohibited from transferring or exchanging all or part of their booths without the organizer's approval.

[Foreign Exhibits]

The exhibition hall will not be a bonded exhibition hall. Exhibits from overseas should be exhibited as domestic cargo or use the ATA Carnet system. For details, please contact the Sponsorship Secretariat.

[Venue management]

IWIPP2027 Organizer or Venue are not responsible for accidents, theft, losses or injury to persons in the booths due to natural disasters or other force majeure events.

[Others]

The Exhibitor manual will be shared with the exhibitors in due course along with the order form for the optional items/services.

Application of Sponsorship / Exhibition

1) How to Apply

Please apply from our official website (<http://iwipp.org/>) on the page of “Sponsorship & Exhibition”.

2) Payment Method

After confirming your application, the Sponsor Secretariat Office will issue an invoice. Please transfer the invoiced amount to the designated bank account within one month of the invoice date. All payments should be made in Japanese Yen, and bank transfer charges are to be borne by the remitter company.

3) Cancellation Policy

- ✓ No cancellations will be accepted after the application form has been submitted. However, if cancellation is caused by unavoidable reasons, please write to the organizer for the circumstances, and the organizer has the right to accept or decline the cancellation or withdrawal requests. If cancellation is approved, you may be charged for expenses incurred at that time.
- ✓ The exhibition period and venue may be changed due to unavoidable circumstances. In principle, applications cannot be cancelled due to such changes. In the event of a postponement, applications that have already been submitted will be moved to the postponed date. No compensation will be provided for damage caused by these changes.
- ✓ Infection control measures: At this time, we hope and assume that the event will be held on site. Depending on public health conditions, the event format may be modified. The organizers shall not be liable for any losses or expenses incurred as a result of such changes.

4) Contact/Inquiries

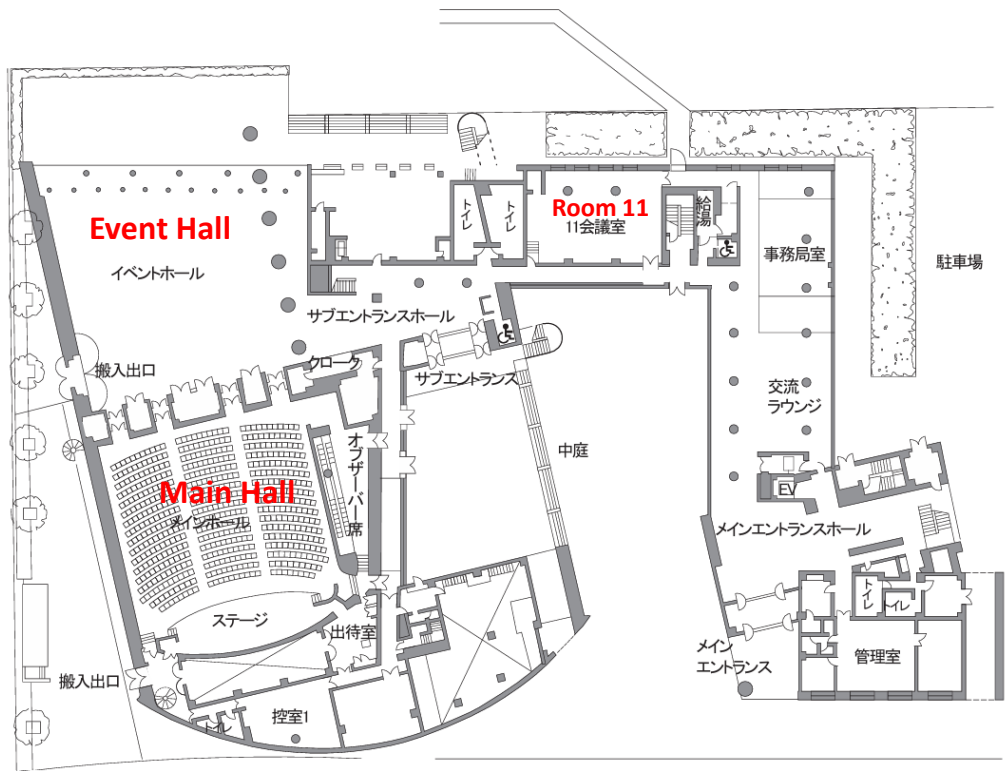
Please contact the IWIPP2027 Sponsorship Office for any inquiries.

IWIPP2027 Sponsorship Office: c/o ENHAL Inc.

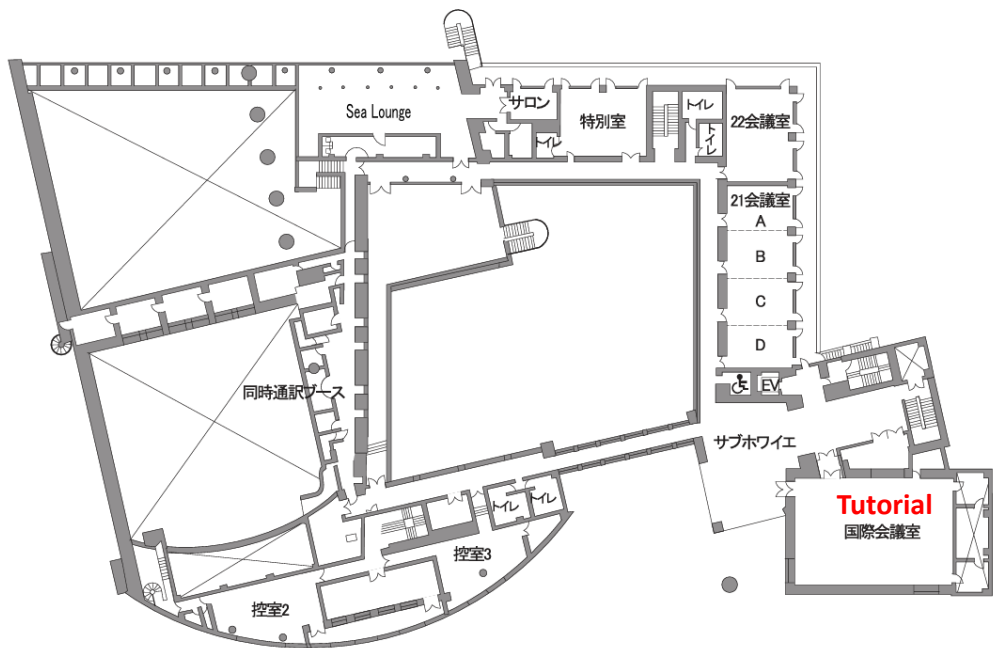
1-8-9 Uchikanda Chiyoda-ku, Tokyo JAPAN

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Appendix (Floor Plan)



First Floor



Second Floor